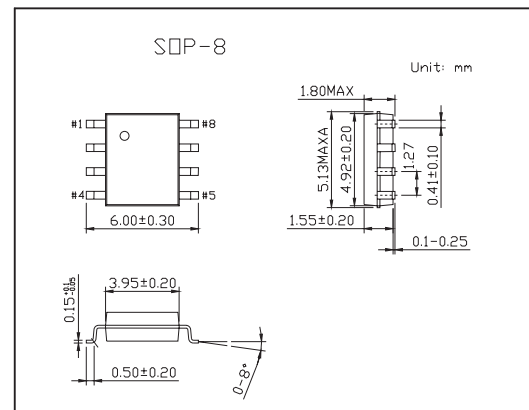
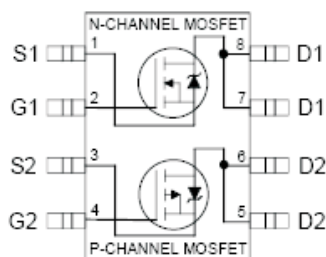


KRF7338

Features

- Ultra Low On-Resistance
- Dual N and P Channel MOSFET
- Surface Mount
- Available in Tape & Reel



Absolute Maximum Ratings $T_a = 25^{\circ}\text{C}$

Parameter	Symbol	N-Channel	P-Channel	Unit
Drain-Source Voltage	V _{DS}	12	-12	V
Continuous Drain Current, V _{GS} @10V , T _a = 25℃	I _D	6.3	-3.0	A
Continuous Drain Current , V _{GS} @10V , T _a = 70℃	I _D	5.2	-2.5	
Pulsed Drain Current *1	I _{DM}	26	-13	
Power Dissipation @T _a = 25℃ *3	P _D	2.0		W
Power Dissipation @T _a = 70℃ *3		1.3		
Linear Derating Factor		16		mW/℃
Gate-to-Source Voltage	V _{GS}	± 12 *4	± 8.0	V
Junction and Storage Temperature Range	T _J , T _{STG}	-55 to + 150		℃
Maximum Junction-to-Ambient *3	R θ JA	62.5		℃/W
Junction-to-Drain Lead	R θ JL	20		

*1 Repetitive rating; pulse width limited by max. junction temperature.

*2 Pulse width $\leq 400 \mu\text{s}$; duty cycle $\leq 2\%$.

*3 Surface mounted on 1 in square Cu board.

*4 The N-channel MOSFET can withstand 15V V_{GS} max
for up to 24 hours over the life of the device.

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■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Testconditons		Min	Typ	Max	Unit
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250 μ A	N-Ch	12			V
		V _{GS} = 0V, I _D = -250 μ A	P-Ch	-12			
Breakdown Voltage Temp. Coefficient	ΔV _{(BR)DSS} / ΔT _J	I _D = 1mA,Reference to 25℃	N-Ch		0.01		V/℃
		I _D = -1mA,Reference to 25℃	P-Ch		-0.01		
Static Drain-to-Source On-Resistance	R _{DS(on)}	V _{GS} = 4.5V, I _D = 6.0A*1	N-Ch			0.034	Ω
		V _{GS} = 3.0V, I _D = 2.0A*1				0.060	
		V _{GS} = -4.5V, I _D = -2.9A*1	P-Ch			0.150	
		V _{GS} = -2.7V, I _D = -1.5A*1				0.200	
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μ A	N-Ch	0.6		1.5	V
		V _{DS} = V _{GS} , I _D = -250 μ A	P-Ch	-0.40		-1.0	
Forward Transconductance	g _{fs}	V _{DS} =6V, I _D = 6.0A*1	N-Ch	9.2			S
		V _{DS} = -6.0V, I _D = -1.5A*1	P-Ch	3.5			
Drain-to-Source Leakage Current	I _{DSS}	V _{DS} = 9.6V, V _{GS} = 0V	N-Ch			20	μ A
		V _{DS} = -9.6V, V _{GS} = 0V	P-Ch			-1.0	
		V _{DS} = 9.6V, V _{GS} = 0V, T _J = 55℃	N-Ch			50	
		V _{DS} = -9.6V, V _{GS} = 0V, T _J = 55℃	P-Ch			-25	
Gate-to-Source Forward Leakage	I _{GSS}	V _{GS} = ± 12V	N-Ch			± 100	nA
		V _{GS} = ± 8V	P-Ch			± 100	
Total Gate Charge	Q _g	N-Channel I _D =6.0A,V _{DS} = 6.0V,V _{GS} =4.5V	N-Ch			8.6	nC
Gate-to-Source Charge	Q _{gs}	P-Channel I _D = -2.9A,V _{DS} = -9.6V,V _{GS} = -4.5V	P-Ch			6.6	
			N-Ch			1.9	
Gate-to-Drain ("Miller") Charge	Q _{gd}		P-Ch			1.3	
			N-Ch			3.9	
Turn-On Delay Time	t _{d(on)}	N-Channel V _{DD} = 6V,I _D = 1.0A,R _G = 6.0 Ω	N-Ch		6.0		ns
			P-Ch		9.6		
Rise Time	t _r		N-Ch		7.6		
			P-Ch		13		
Turn-Off Delay Time	t _{d(off)}	P-Channel V _{DD} = -28V,I _D = -1.0A,R _G = 6.0 Ω V _{GS} = -4.5V	N-Ch		26		
			P-Ch		27		
Fall Time	t _f		N-Ch		34		
			P-Ch		25		
Input Capacitance	C _{iss}	N-Channel V _{GS} = 0V,V _{DS} = 9.0V,f = 1.0MHz	N-Ch		640		pF
			P-Ch		490		
Output Capacitance	C _{oss}		N-Ch		340		
			P-Ch		80		
Reverse Transfer Capacitance	C _{rss}	P-Channel V _{GS} = 0V,V _{DS} = -9.0V,f = 1.0MHz	N-Ch		110		
			P-Ch		58		

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■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Testconditons		Min	Typ	Max	Unit
Continuous Source Current (Body Diode)	Is		N-Ch			6.3	A
			P-Ch			-3.0	
Pulsed Source Current (Body Diode) *2	ISM		N-Ch			26	
			P-Ch			-13	
Diode Forward Voltage	VSD	TJ = 25℃, Is = 1.7A, VGS = 0V*1	N-Ch			1.3	V
		TJ = 25℃, Is = -2.9A, VGS = 0V*1	P-Ch			-1.2	
Reverse Recovery Time	trr	N-Channel	N-Ch		51	76	ns
		TJ = 25℃, IF =1.7A,di/dt = 100A/ μ s*1	P-Ch		37	56	
Reverse RecoveryCharge	Qrr	P-Channel	N-Ch		43	64	nC
		TJ=25℃, IF=-2.9A,di/dt=-100A/ μ s*1	P-Ch		20	30	

*1 Pulse width ≤ 400 μs; duty cycle ≤ 2%.

*2 Repetitive rating; pulse width limited by max. junction temperature.